芯伯乐®
XINBOLE

Product Specification

XBLW CD4012

Dual 4-input Nand Gate

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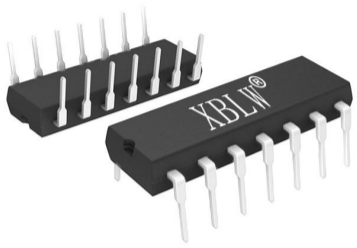
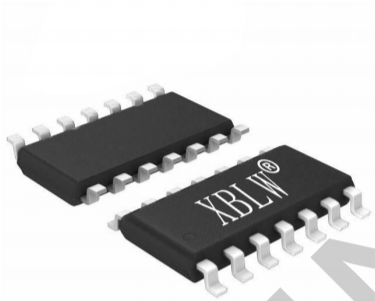
Description

The CD4012 is a Dual 4-input Nand Gate. The outputs are fully buffered for the highest noise immunity and pattern insensitivity to output impedance.

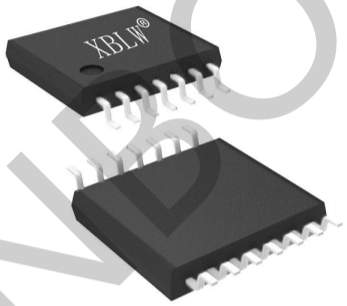
It operates over a recommended V_{DD} power supply range of 3V to 15V referenced to GND (usually ground). Unused inputs must be connected to V_{DD}, GND, or another input.



DIP-14



SOP-14



TSSOP-14

Feature

- Wide supply voltage range from 3V to 15V
- Fully static operation
- Fully static operation
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Specified from -40℃ to +105℃
- Packaging information: DIP14/SOP14/TSSOP14

Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW CD4012BE	DIP-14	CD4012BE	Tube	1000Pcs/Box
XBLW CD4012BDTR	SOP-14	CD4012B	Tape	2500Pcs/Reel
XBLW CD4012BTDTR	TSSOP-14	CD4012B	Tape	3000Pcs/Reel

Block Diagram And Pin Description

Block Diagram

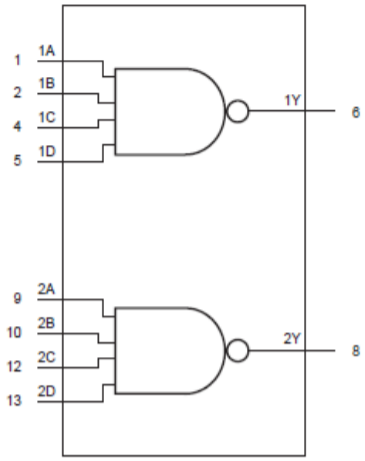


Figure 1. Logic symbol

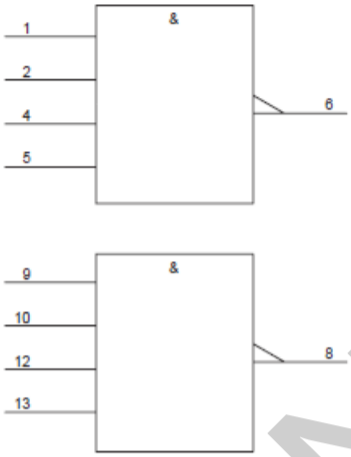


Figure 2. IEC Logic symbol

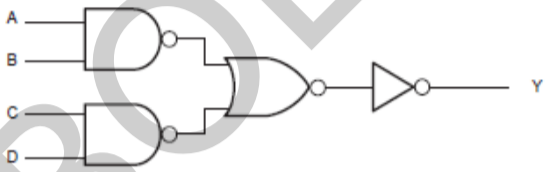
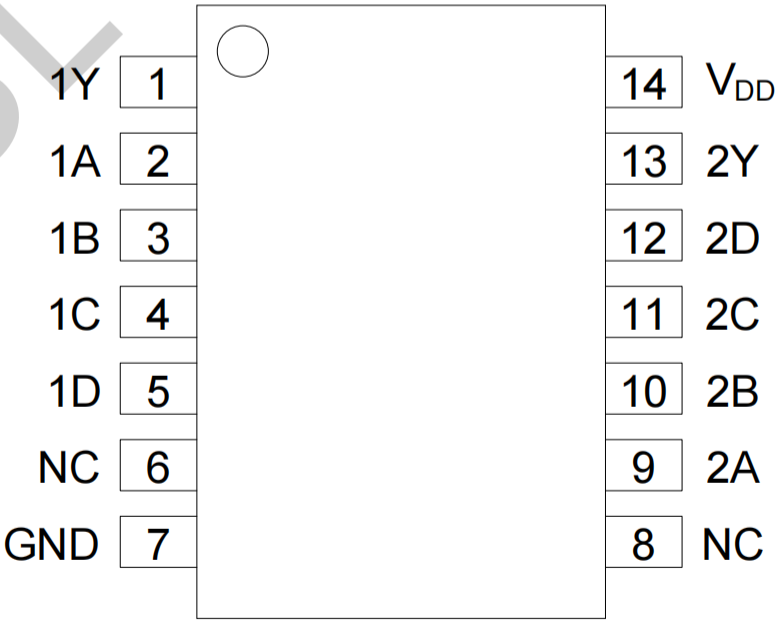


Figure 3. Logic diagram

Pin Configurations



Pin Description

Pin No.	Pin Name	Description
1	1Y	data output
2	1A	data input
3	1B	data input
4	1C	data input
5	1D	data input
6	NC	no connection
7	GND	ground(0V)
8	NC	no connection
9	2A	data input
10	2B	data input
11	2C	data input
12	2D	data input
13	2Y	data output
14	V_{DD}	supply voltage

Function Table

Input				Output
nA	nB	nC	nD	nY
L	X	X	X	H
X	L	X	X	H
X	X	L	X	H
X	X	X	L	H
H	H	H	H	L

Note: H=HIGH voltage level; L=LOW voltage level; X=Don't care.

Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Max.	Unit
supply voltage	V_{DD}	-		-0.5	+18	V
DC input current	I_{IK}	any one input		-	±10	mA
input voltage	V_I	all inputs		-0.5	V_{DD}+0.5	V
storage temperature	T_{stg}	-		-65	+150	℃
total power dissipation	P_{tot}	-		-	500	mW
device dissipation	P	per output transistor		-	100	mW
Soldering temperature	T_L	10s	DIP	245		℃
			SOP/TSSOP	260		℃

Note:

[1] For DIP14 packages: above 70℃ the value of P_{tot} derates linearly with 12mW/K.

[2] For SOP14 packages: above 70℃ the value of P_{tot} derates linearly with 8mW/K.

[3] For (T)SSOP14 packages: above 60℃ the value of P_{tot} derates linearly with 5.5mW/K.

Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{DD}	-	3	-	15	V
ambient temperature	T_{amb}	in free air	-40	-	+105	℃

Electrical Characteristics

DC Characteristics 1 (Tamb=25℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions(V)			Tamb=25°C			Unit
		VO	VIN	VDD	Min.	Typ.	Max.	
supply current	I_{DD}	-	0, 5	5	-	0.01	0.25	μA
		-	0, 10	10	-	0.01	0.5	μA
		-	0, 15	15	-	0.01	1	μA
LOW-level output current	I_{OL}	0.4	0, 5	5	0.51	1	-	mA
		0.5	0, 10	10	1.3	2.6	-	mA
		1.5	0, 15	15	3.4	6.8	-	mA
HIGH-level output current	I_{OH}	4.6	0, 5	5	-0.51	-1	-	mA
		2.5	0, 5	5	-1.6	-3.2	-	mA
		9.5	0, 10	10	-1.3	-2.6	-	mA
		13.5	0, 15	15	-3.4	-6.8	-	mA
LOW-level output voltage	V_{OL}	-	0, 5	5	-	0	0.05	V
		-	0, 10	10	-	0	0.05	V
		-	0, 15	15	-	0	0.05	V
HIGH-level output voltage	V_{OH}	-	0, 5	5	4.95	5	-	V
		-	0, 10	10	9.95	10	-	V
		-	0, 15	15	14.95	15	-	V
LOW-level input voltage	V_{IL}	4.5	-	5	-	-	1.5	V
		9	-	10	-	-	3	V
		13.5	-	15	-	-	4	V
HIGH-level input voltage	V_{IH}	0.5, 4.5	-	5	3.5	-	-	V
		1, 9	-	10	7	-	-	V
		1.5, 13.5	-	15	11	-	-	V
input leakage current	I_I	-	0, 15	15	-	-	±1	μA

DC Characteristics 2

(Tamb=-40℃ to +105℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions(V)			Tamb=-40°C		Tamb=+85°C		Tamb=+105°C		Unit
		VO	VIN	VDD	Min.	Max.	Min.	Max.	Min.	Max.	
supply current	I_{DD}	-	0, 5	5	-	0.25	-	7.5	-	7.5	μA
		-	0, 10	10	-	0.5	-	15	-	15	μA
		-	0, 15	15	-	1	-	30	-	30	μA
LOW-level output current	I_{OL}	0.4	0, 5	5	0.61	-	0.42	-	0.36	-	mA
		0.5	0, 10	10	1.5	-	1.1	-	0.9	-	mA
		1.5	0, 15	15	4	-	2.8	-	2.4	-	mA
HIGH-level output current	I_{OH}	4.6	0, 5	5	-0.61	-	-0.42	-	-0.36	-	mA
		2.5	0, 5	5	-1.8	-	-1.3	-	-1.15	-	mA
		9.5	0, 10	10	-1.5	-	-1.1	-	-0.9	-	mA
		13.5	0, 15	15	-4	-	-2.8	-	-2.4	-	mA
LOW-level output voltage	V_{OL}	-	0, 5	5	-	0.05	-	0.05	-	0.05	V
		-	0, 10	10	-	0.05	-	0.05	-	0.05	V
		-	0, 15	15	-	0.05	-	0.05	-	0.05	V
HIGH-level output voltage	V_{OH}	-	0, 5	5	4.95	-	4.95	-	4.95	-	V
		-	0, 10	10	9.95	-	9.95	-	9.95	-	V
		-	0, 15	15	14.95	-	14.95	-	14.95	-	V
LOW-level input voltage	V_{IL}	4.5	-	5	-	1.5	-	1.5	-	1.5	V
		9	-	10	-	3	-	3	-	3	V
		13.5	-	15	-	4	-	4	-	4	V
HIGH-level input voltage	V_{IH}	0.5, 4.5	-	5	3.5	-	3.5	-	3.5	-	V
		1, 9	-	10	7	-	7	-	7	-	V
		1.5, 13.5	-	15	11	-	11	-	11	-	V
input leakage current	I_I	-	0, 15	15	-	±1	-	±1	-	±1	μA

AC Characteristics (T_{amb}=25℃, GND=0V, t_r, t_f=20ns, C_L=50pF, R_L=200KΩ, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
propagation delay time	t_{PHL}, t_{PLH}	see Figure 5	V_{DD}=5V	-	125	250	ns
			V_{DD}=10V	-	60	120	ns
			V_{DD}=15V	-	45	90	ns
transition time	t_{THL}, t_{TLH}	see Figure 5	V_{DD}=5V	-	100	200	ns
			V_{DD}=10V	-	50	100	ns
			V_{DD}=15V	-	40	80	ns
input capacitance	C_I	any input		-	5	7.5	pF

Testing Circuit

AC Testing Circuit

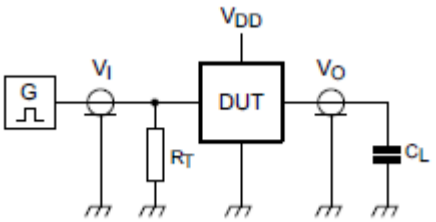


Figure 4. Test circuit for switching times

Definitions for test circuit: DUT=Device Under Test

C_L=Load capacitance including jig and probe capacitance.

R_T=Termination resistance should be equal to the output impedance Z_o of the pulse generator.

AC Testing Waveforms

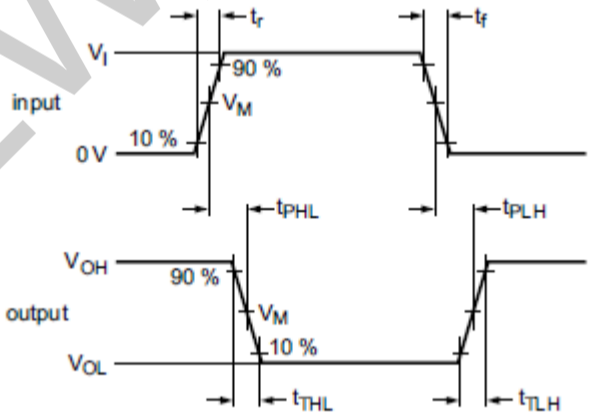


Figure 5. Propagation delay, output transition time

Measurement Points

Supply voltage	Input	Output
V_{DD}	V_M	V_M
5V to 15V	$0.5\times V_{DD}$	$0.5\times V_{DD}$

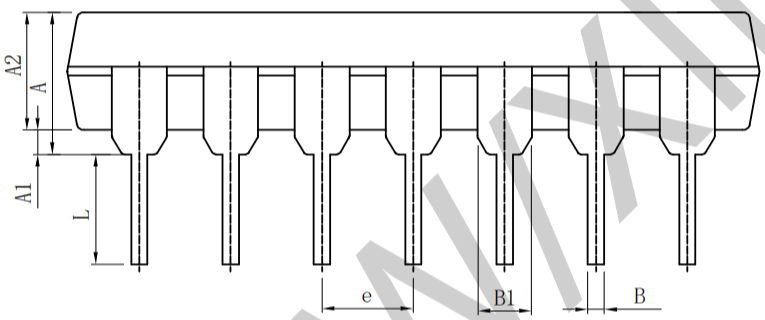
Test Data

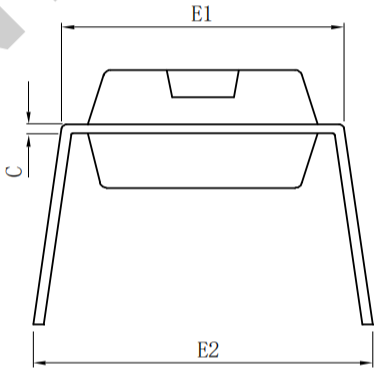
Supply voltage	Input		Load
V_{DD}	V_I	t_r, t_f	C_L
5V to 15V	GND or V_{DD}	≤20ns	50pF

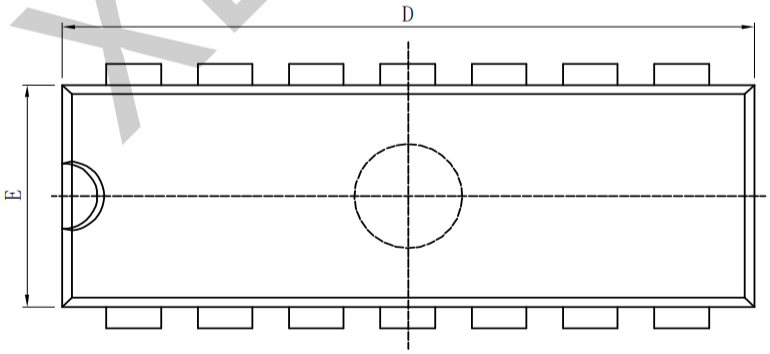
Package Information

· DIP-14

Size / Symbol	Dimensions In Millimeters		Size / Symbol	Dimensions In Inches	
	Min(mm)	Max(mm)		Min(in)	Max(in)
A	3.710	4.310	A	0.146	0.170
A1	0.510		A1	0.020	
A2	3.200	3.600	A2	0.126	0.142
B	0.380	0.570	B	0.015	0.022
B1	1.524(BSC)		B1	0.060(BSC)	
C	0.204	0.360	C	0.008	0.014
D	18.800	19.200	D	0.740	0.756
E	6.200	6.600	E	0.244	0.260
E1	7.320	7.920	E1	0.288	0.312
e	2.540(BSC)		e	0.100(BSC)	
L	3.000	3.600	L	0.118	0.142
E2	8.400	9.000	E2	0.331	0.354

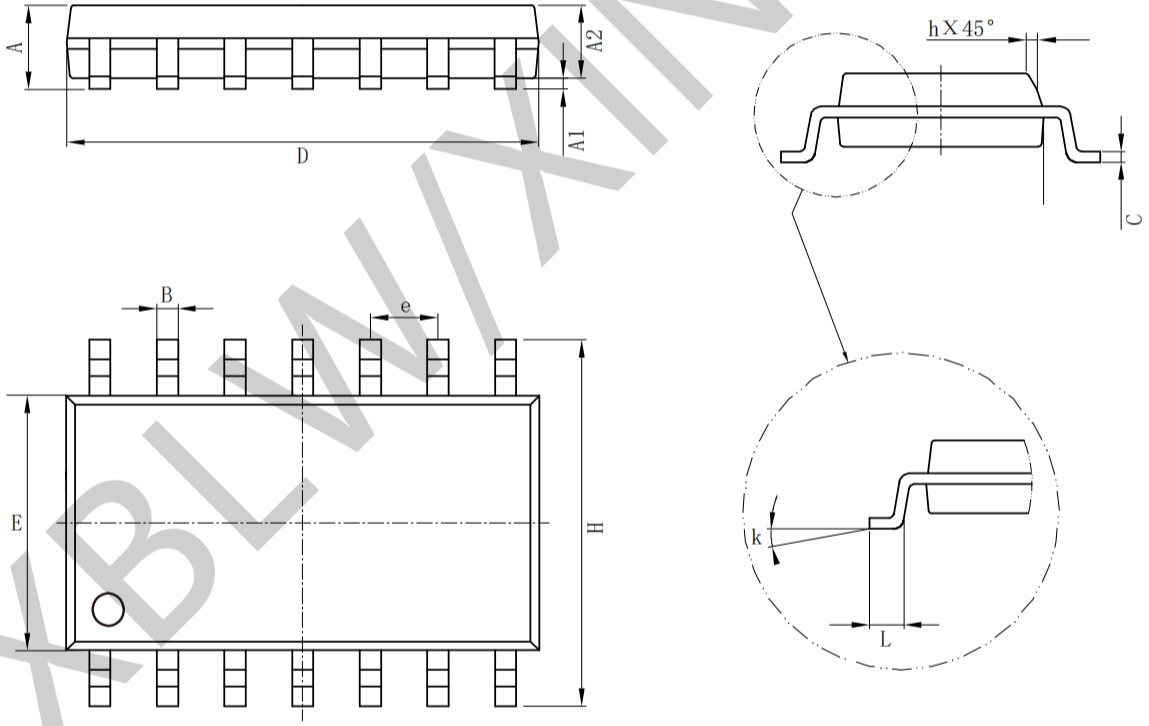






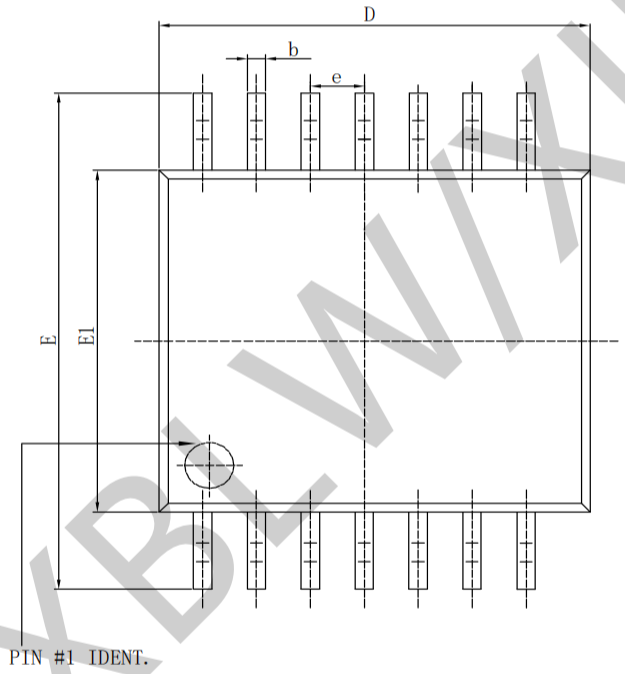
· SOP-14

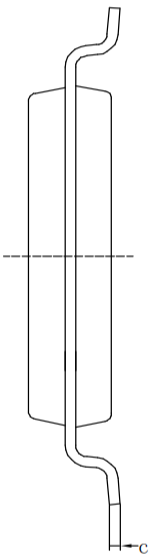
Size / Symbol	Dimensions In Millimeters		Size / Symbol	Dimensions In Inches	
	Min(mm)	Max(mm)		Min(in)	Max(in)
A	1.350	1.750	A	0.050	0.068
A1	0.100	0.250	A1	0.004	0.009
A2	1.100	1.650	A2	0.040	0.060
B	0.330	0.510	B	0.010	0.020
C	0.190	0.250	C	0.007	0.009
D	8.550	8.750	D	0.330	0.340
E	3.800	4.000	E	0.150	0.150
e	1.27		e	0.05	
H	5.800	6.200	H	0.220	0.240
h	0.250	0.500	h	0.009	0.020
L	0.400	1.270	L	0.015	0.050
k	8° (max)		k	8° (max)	

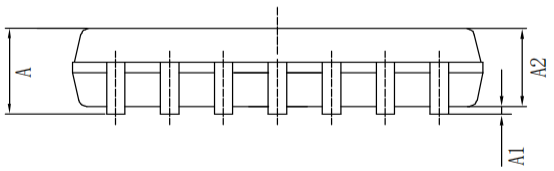


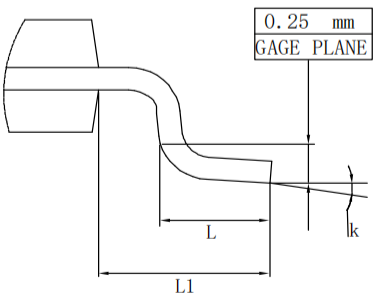
· TSSOP-14

Size / Symbol	Dimensions In Millimeters		Size / Symbol	Dimensions In Inches	
	Min(mm)	Max(mm)		Min(in)	Max(in)
A		1.200	A		0.047
A1	0.050	0.150	A1	0.002	0.006
A2	0.800	1.050	A2	0.031	0.041
b	0.190	0.300	b	0.007	0.012
c	0.090	0.200	c	0.004	0.0089
D	4.900	5.100	D	0.193	0.201
E	6.200	6.600	E	0.244	0.260
E1	4.300	4.500	E1	0.169	0.176
e	0.65		e	0.0256	
L	0.450	0.750	L	0.018	0.030
L1	1.00		L1	0.039	
k	0°	8°	k	0°	8°









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